

C1206X475K9RACTU

Aliases (C1206X475K9RAC7800) SMD Comm X7R Flex, Ceramic, 4.7 uF, 10%, 6.3 VDC, X7R, SMD, MLCC, FT-CAP, Temperature Stable, 1206, 1.5 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X7R Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Temperature Stable
Features	FT-CAP, Temperature Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	55 mg
Shelf Life	78 Weeks
MSL	1

	Specifications	
	Capacitance	4.7 uF
	Measurement Condition	1 kHz 1.0Vrms
	Tolerance	10%
	Voltage DC	6.3 VDC
	Dielectric Withstanding Voltage	15.75 VDC
	Temperature Range	-55/+125°C
1	Temp. Coefficient	X7R
	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
	Dissipation Factor	10% 1 kHz 1.0Vrms
	Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
	Insulation Resistance	21.3 MOhms

 Dimensions

 Chip Size
 1206

 L
 3.3mm +/-0.4mm

 W
 1.6mm +/-0.35mm

 T
 1.6mm +/-0.35mm

 S
 1.5mm MIN

 B
 0.6mm +/-0.25mm

Packaging Specifications

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	2000

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